


SPECIFICATION SHEET NO.	S0317 - SDR345M000S013	
ORIGINAL MFG/PART NO.	TGS Crystals/SDR 345.0MB TLF/R345S13	
NEXTGEN PART CODE	SDR345M000S013	Indicate This Code For <a href="#">RFQ</a> /Order
DATE	Mar. 17, 2025	
REVISION	A2	Updated With Most Recent Data
DESCRIPTION AND MAIN PARBMETRICS	<p>SMD SAW Resonator, 6 Pads, 3030 Type, SDR Series</p> <p>Dimension L3.0*W3.0*H1.25mm</p> <p>Center Frequency 345.000MHz; Frequency Tolerance <math>\pm 100\text{KHz}</math></p> <p>Insertion Loss: 1.2dB Typical, 2.0dB Max.</p> <p>Operating Temp. Range -40°C ~ +85°C</p> <p>Reflow Profile Condition 260°C Max.</p> <p>Package in Tape/Reel, 3000pcs/Reel</p> <p>REACH/RoHS/RoHS III Compliant</p>	
CUSTOMER		
CUSTOMER PART NUMBER		
CROSS REF. PART NUMBER		
MEMO		

VENDOR APPROVE		
Issued/Checked/Approved		
Effective Date: Mar. 17, 2025		

CUSTOMER APPROVE
Date:

## MAIN FEATURE

- SMD SAW Resonator 3030 Type 6 Pads
- Dimension L3.0\*W3.0\*H1.25mm
- Low-loss SAW Resonator
- One Port SAW Resonator
- Ceramic Package For Surface Mounted Technology (SMT)
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level (MSL) 1
- Short Lead time
- Cross Competitors Parts and More
- REACH/RoHS/RoHS III Compliant



*Image shown is a representation only. Exact specifications should be obtained from the product dimension.*



## APPLICATION

- Bluetooth, Wireless Communication Set
- Communication Electronics

## ELECTRICAL CHARBCTERISTICS

- See Page 5
- All Products Parameters are Subject To NextGen Components' Final Confirmation.

### HOW TO ORDER

- Please Follow Up Part Code Guide And Indicate NextGen Part Code SDR345M000S013 For RFQ and Order.

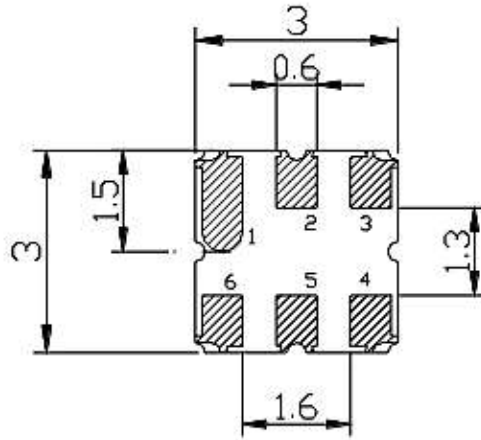
### PART CODE GUIDE

**RFQ**  
[Request For Quotation](#)

CODE	NAME	KEY SPECIFICATION OPTION
SDR	Series Code	SMD SAW Resonator, 6 Pads, 3030 Type Dimension L3.0*W3.0*H1.25mm
345M0	Frequency Range Code	345M0: 345.000MHz
S013	Internal Control Code	Letter A~Z, a~z or Digits (1-9)
XX	Special/Custom Parameters Code	Blank: N/A XX: Letter A~Z, a~z or Digits (0~9) for Special/Custom Parameters

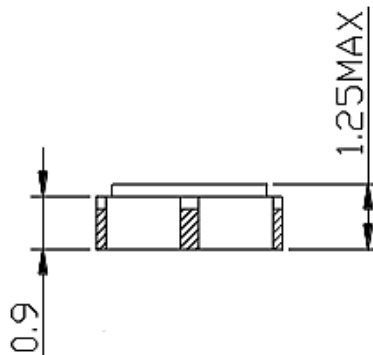
**DIMENSION** - Unit: mm, L3.0\*W3.0\*H1.25mm

Bottom View



PIN	CONFIGURATION
2	Input/Output
5	Output/Input
1, 3, 4, 6	Case Ground

Side View



**MAX. RATING & CHARACTERISTICS** - At 25±2°C Ambient Temperature Unless Otherwise Specified.

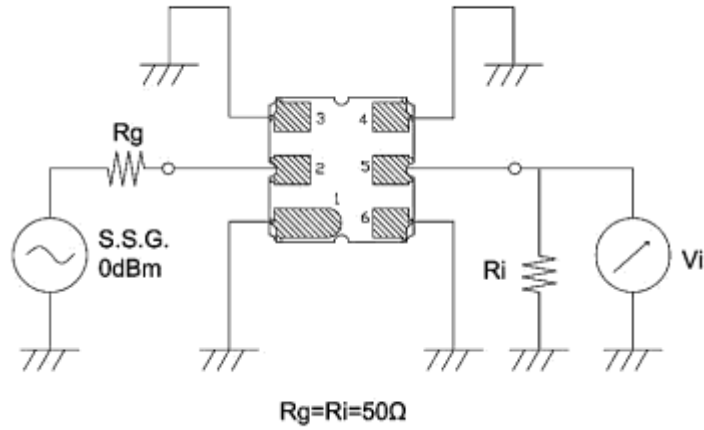
PARAMETER	SYMBOLS	VALUE	UNITS
RF Power Level	P	15	dBm
DC Voltage	V <sub>DC</sub>	±30	V
Operating Temperature Range	T <sub>A</sub>	-40 to +85	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to +85	°C

**ELECTRONICAL CHARACTERISTICS**

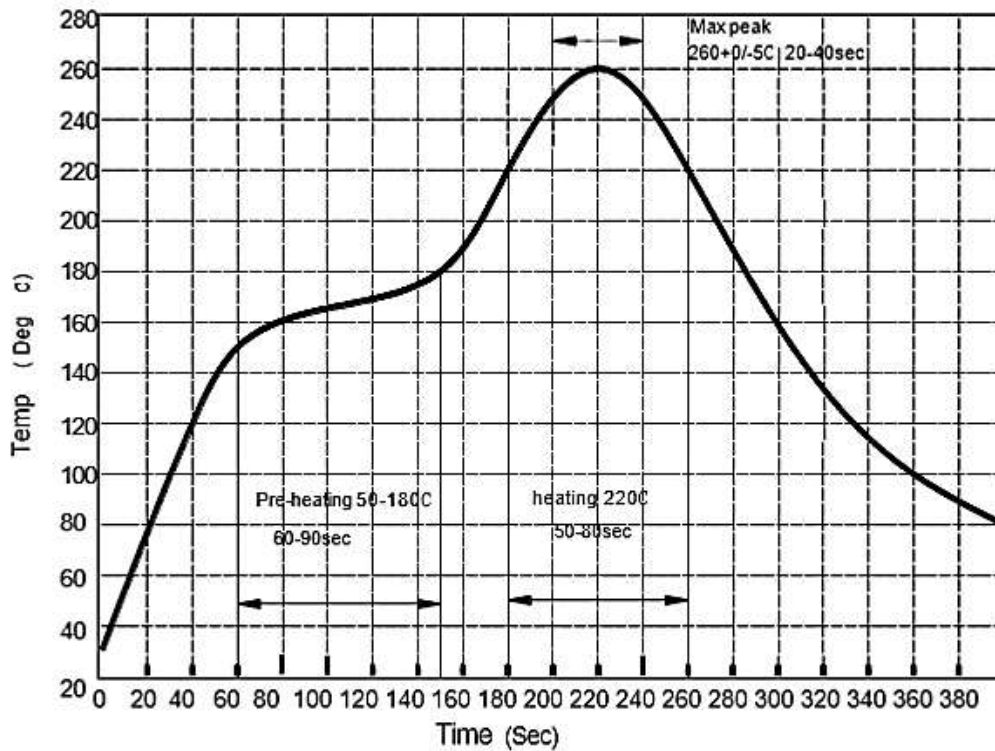
1) Test Temperature: 25°C±2°C 2) Terminating source impedance: 50Ω 3) Terminating load impedance: 50Ω .

PARAMETER		SYMBOLS	CHARACTERISTICS			
			MIN.	TYPICAL	MAX.	UNIT
Center Frequency- Absolute Frequency		F <sub>C</sub>	-	345.000	-	MHz
Frequency Tolerance from 345.000MHz		Δf <sub>c</sub>	-	±100	-	KHz
Insertion Loss		IL	-	1.2	2.0	dB
Quality	Unloaded Q	Q <sub>U</sub>	-	16621	-	
Factor	50Ω Loaded Q	Q <sub>L</sub>	-	1917	-	
Frequency Aging	Absolute Value during the 1 <sup>st</sup> Year	f <sub>A</sub>	-	≤10	-	ppm/yr
DC Insulation Resistance between Any Two Pins			1.0	-	-	MΩ
RF Equivalent RLC Model	Motional Resistance	R <sub>M</sub>	-	13	26	Ω
	Motional Inductance	L <sub>M</sub>	-	101.46	-	μH
	Motional Capacitance	C <sub>M</sub>	-	2.16	-	fF
	Static Capacitance	C <sub>0</sub>	2.65	2.95	3.25	pF

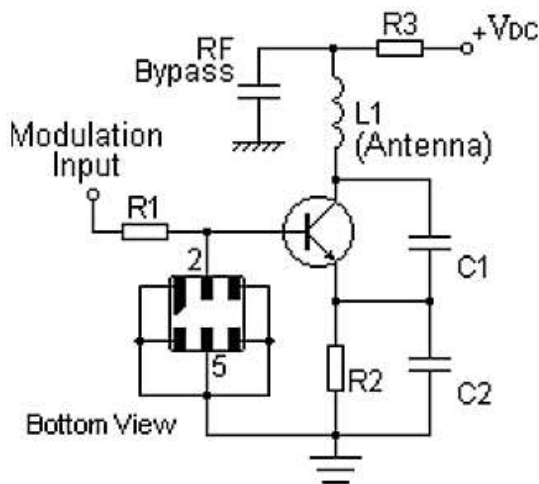
**MEASUREMENT CIRCUIT – FOR REFERENCE ONLY**



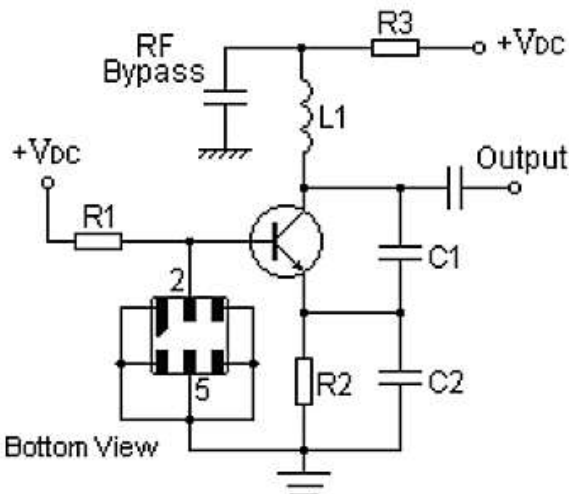
**RECOMMENDED SOLDERING PROFILE – FOR REFERENCE ONLY**



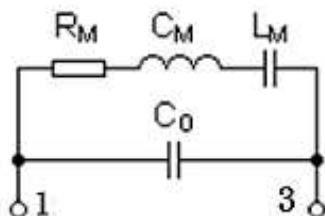
**TYPICAL LOW-POWER TRANSMITTER APPLICATION – FOE REFERENCE ONLY**



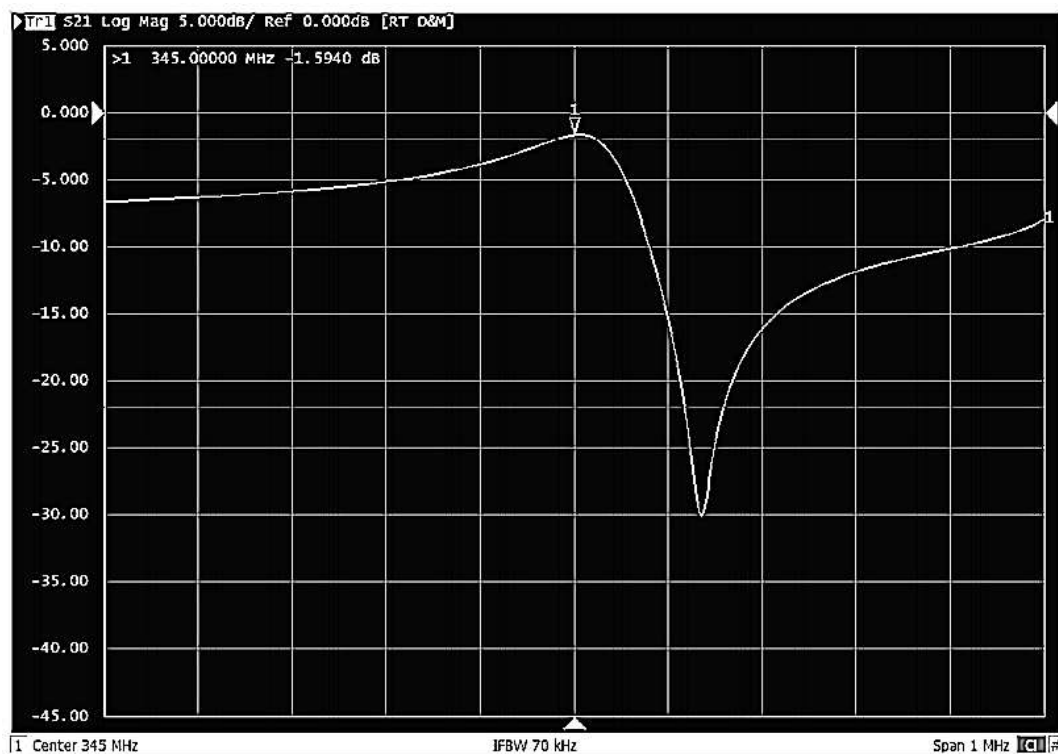
**TYPICAL LOCAL OSCILLATOR APPLICATION – FOE REFERENCE ONLY**



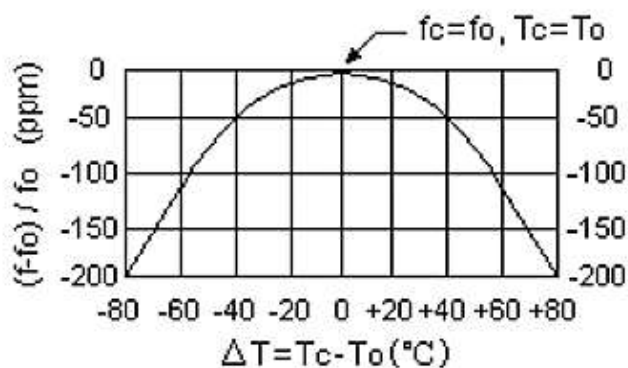
**EQUIVALENT LC MODEL – FOR REFERENCE ONLY**



## FREQUENCY RESPONSE – FOR REFERENCE ONLY



## TEMPERATURE CHARACTERISTICS – FOR REFERENCE ONLY



- Note: The curve shown above accounts for resonator contribution only and does not include LC component temperature contributions.



## RELIABILITY CHARACTERISTICS

TEST ITEMS	TEST METHOD AND CONDITIONS
Temperature Storage	<ul style="list-style-type: none"> <li>Temperature: <math>85^{\circ}\text{C} \pm 2^{\circ}\text{C}</math>, Duration: 250h , Recovery time: <math>2\text{h} \pm 0.5\text{h}</math></li> <li>Temperature: <math>-40^{\circ}\text{C} \pm 3^{\circ}\text{C}</math>, Duration: 250h ,Recovery time: <math>2\text{h} \pm 0.5\text{h}</math></li> </ul>
Humidity Test	<ul style="list-style-type: none"> <li>Conditions: <math>60^{\circ}\text{C} \pm 2^{\circ}\text{C}</math> , 90~95% RH, Duration: 250h</li> </ul>
Thermal Shock	<ul style="list-style-type: none"> <li>Heat cycle conditions: <math>\text{TA} = -40^{\circ}\text{C} \pm 3^{\circ}\text{C}</math>, <math>\text{TB} = 85^{\circ}\text{C} \pm 2^{\circ}\text{C}</math>, <math>t_1 = t_2 = 30\text{min}</math>,</li> <li>Switch time: <math>\leq 3\text{min}</math>, Cycle time: 100 times,</li> <li>Recovery time: <math>2\text{h} \pm 0.5\text{h}</math>.</li> </ul>
Vibration Fatigue	<ul style="list-style-type: none"> <li>Frequency of vibration: 10~55Hz, Amplitude:1.5mm</li> <li>Directions: X,Y and Z, Duration: 2h</li> </ul>
Drop Test	<ul style="list-style-type: none"> <li>Cycle time: 10 times, Height: 1.0m</li> </ul>
Solderability	<ul style="list-style-type: none"> <li>Temperature: <math>245^{\circ}\text{C} \pm 5^{\circ}\text{C}</math>, Duration: 3.0s--5.0s, Depth: DIP--2/3 , SMD--1/5</li> </ul>
Resistance to Soldering Heat	<ul style="list-style-type: none"> <li>Thickness of PCB:1mm , Solder condition: <math>260^{\circ}\text{C} \pm 5^{\circ}\text{C}</math> , Duration: <math>10 \pm 1\text{s}</math></li> <li>Temperature of Soldering Iron: <math>350^{\circ}\text{C} \pm 10^{\circ}\text{C}</math> , Duration: 3~4s ,</li> <li>Recovery time : <math>2 \pm 0.5\text{h}</math></li> </ul>
Remarks	<ul style="list-style-type: none"> <li>As a result of the particularity of inner structure of SAW products, it easy to be breakdown by electrostatic, so we should pay attention to ESD protect in the test.</li> <li>Static voltage between signal load and ground may cause deterioration and destruction of the component. Please avoid static voltage.</li> <li>Ultrasonic cleaning may cause deterioration and destruction of the component. Please avoid ultrasonic cleaning.</li> <li>Only leads of component may be soldered. Please avoid soldering another part of component.</li> <li>There is a close relationship between the device's performance and matching network. The specifications of this device are based on the test circuit shown above. L and C values may change depending on board layout. Values shown are intended as a guide only.</li> </ul>

Technical drawing of a mechanical part, likely a bracket or support, showing dimensions and tolerances. The drawing includes a top view and a side view.

**Top View Dimensions:**

- Overall width:  $12.00^{+0.10}_{-0.10}$
- Distance from left edge to first hole center:  $2.00^{+0.10}_{-0.10}$
- Distance between hole centers:  $1.50^{+0.10}_{-0.00}$
- Distance from last hole center to right edge:  $4.00^{+0.10}_{-0.10}$
- Distance from left edge to first square feature center:  $2.00^{+0.10}_{-0.10}$
- Distance between square feature centers:  $1.50^{+0.10}_{-0.00}$
- Distance from last square feature center to right edge:  $4.00^{+0.10}_{-0.10}$
- Distance from top edge to first hole center:  $1.75^{+0.10}_{-0.10}$
- Distance from top edge to first square feature center:  $5.50^{+0.05}_{-0.05}$
- Distance from top edge to bottom edge:  $12.00^{+0.10}_{-0.10}$
- Distance from right edge to center of last square feature:  $4.00^{+0.10}_{-0.10}$

**Side View Dimensions:**

- Overall height:  $16.00^{+0.05}_{-0.05}$
- Distance from top edge to first hole center:  $3.20^{+0.05}_{-0.05}$
- Distance from top edge to first square feature center:  $3.20^{+0.05}_{-0.05}$
- Distance from top edge to bottom edge:  $1.60^{+0.05}_{-0.05}$
- Distance from right edge to center of last square feature:  $0.30^{+0.05}_{-0.05}$

The diagram illustrates the structure of a magnetic tape. It is divided into sections labeled 'vacant', 'components contained', 'vacant', and 'Leader part'. The 'components contained' section is further divided into 'vacant' and 'components contained' sub-sections. The dimensions are indicated as 150mm min for the first two 'vacant' sections, 150mm min for the second 'vacant' section, and 250mm min for the 'Leader part'. The tape running direction is indicated by an arrow pointing to the right.

## IMPORTANT NOTES AND DISCLAIMER

1. **ROHS COMPLIANCE:** The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU RoHS Directive (EU) 2015/863 EC (RoHS3). RoHS Test Report for this product can be obtained at Download Center.
2. **REACH COMPLIANCE:** REACH substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, REACH Test Report for this product can be obtained at Download Center.
3. All Product parametric performance is indicated in the Electrical Characteristics for the listed herein test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
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7. *NextGen* products are not authorized for use as critical components in life support devices or systems without express written approval by *NextGen*.
8. *NextGen* requires that customers first obtain an RMA (Returned Merchandise Authorization) number prior to returning any products. Returns must be made within 30 days of the date of invoice, be in the original packaging, unused and like-new condition. At the time of quoting or purchasing, a product may say that it is Non-Cancelable/ Non-Returnable (NCNR). These products are not returnable and not refundable.